

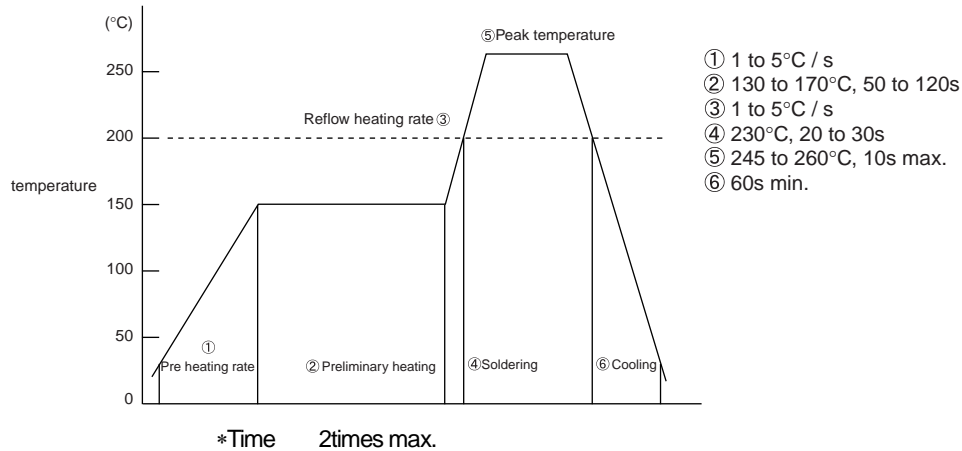
Condition of soldering for
Surface mounted mold Diodes
Lead free paste
(Sn-3Ag-0.5Cu) version

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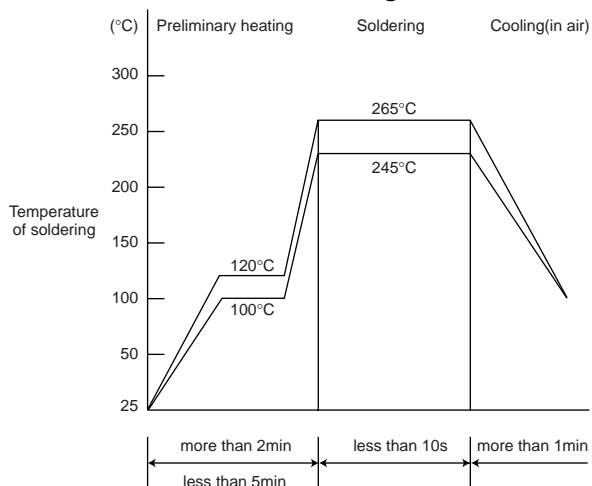
Surface mounted mold Diodes

● Recommended condition of reflow soldering



Recommended peak temperature is over 245°C. If peak temperature is below 245°C, you may adjust the following parameters ; Time length of peak temperature (longer), Time length of soldering (longer), Thickness of solder paste (thicker).

● Recommended condition of flow soldering



● Condition of hand soldering

Temperature	refer to right table
Time	less than 3s
Times	one time

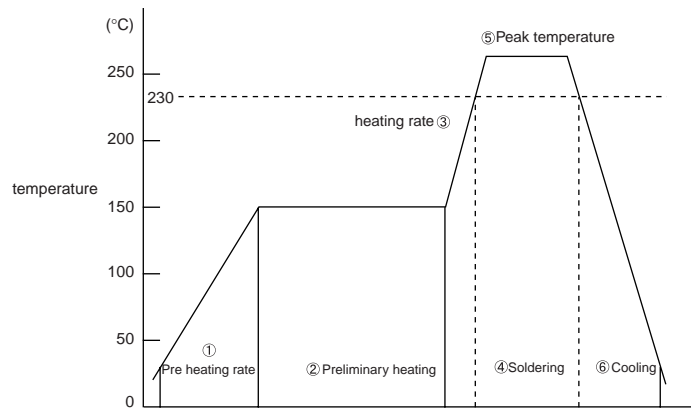
Temperature differ from PKG

PKG less than 400°C
 SMD3, SMD4, SMD5, SMD6, SSD3,
 UMD2(except for 1SS355, 1SS380, 1SS376, UDZ S series)
 UMD3, UMD4, UMD5, UMD6,
 EMD2, EMD3, EMD4, EMD5, EMD6,
 VMN2, VMD2, VMD3,
 TUMD2, TSMD5, TSMD6,
 MPD, CPD, LLDS, LLDL

PKG less than 350°C
 UMD2(1SS355, 1SS380, 1SS376, UDZ S series)
 PMDU, PMDS, PMDT

Surface mounted mold Diodes

● Condition of heat-resistant



- ① 1 to 5°C / s
- ② 150 to 180°C, 60 to 120s
- ③ 1 to 5°C / s
- ④ 230°C, 20 to 40s
- ⑤ 260°C max, 10s max.
- ⑥ 60s min.

* Time 2Times max.

Surface mounted mold Diodes

● Recommended condition of washing

1. Washing liquid

washing liquid	manufacturers
water	—
ethanol	—
methanol	—
pine alpha ST-100S	ARAKAWA CHEMICAL
clean through 750H	KAO
technocare FRW-1	TOSHIBA TECHNOCARE
mighty solve AH-V	ASAHI GLASS

2. Condition of washing

washing bath		time	temperature	remarks
first bath	ultrasonic bath	less than 60s	room temperature	25 to 28kHz, 15W / L
second bath	immersion bath	less than 60s	room temperature	
third bath	vaper bath *	less than 60s	less than 44.7°C	boiling points differ to washing liquid

* In vaper bath, you can not use ethanol, methanol and water due to their high boiling points.

Soldering conditions

Surface mounted mold Diodes

● Reference to copper plate area dimension on printed circuit board

unit:mm

Terminal	2pin	Terminal	3pin	Terminal	4pin	Terminal	5pin	Terminal	6pin
UMD2		EMD3		UMD4		UMD5		UMD6	
PMD5		UMD3		SMD4		SMD5		SMD6	
EMD2		SMD3,SSD3		EMD4		EMD5		EMD6	
PMDU		VMD3					TSMD5		TSMD6
VMD2									
TUMD2									
PMDT									
VMN2									

MPD	CPD3

*Copper plate area dimensions above are reference dimensions with being soldered with conditions below.

PCB	FR-4,t=1.6mm
Solder paste	M705-GRN360-K2V
Paste thickness	150um
Reflow soldering	max. 250°C,10s

Solderability will depend on the soldering conditions,solder paste, paste thickness,soldering pad size, mount layout and so on. So, it is difficult for ROHM to refer to customer's soldering conditions.

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